

MS-6782 Ver:10A

CPU:

Pentium4 socket-478 Processor

System Chipset:

SIS648FX(NB) + SIS963LC1(SB)

On Board Function Chip:

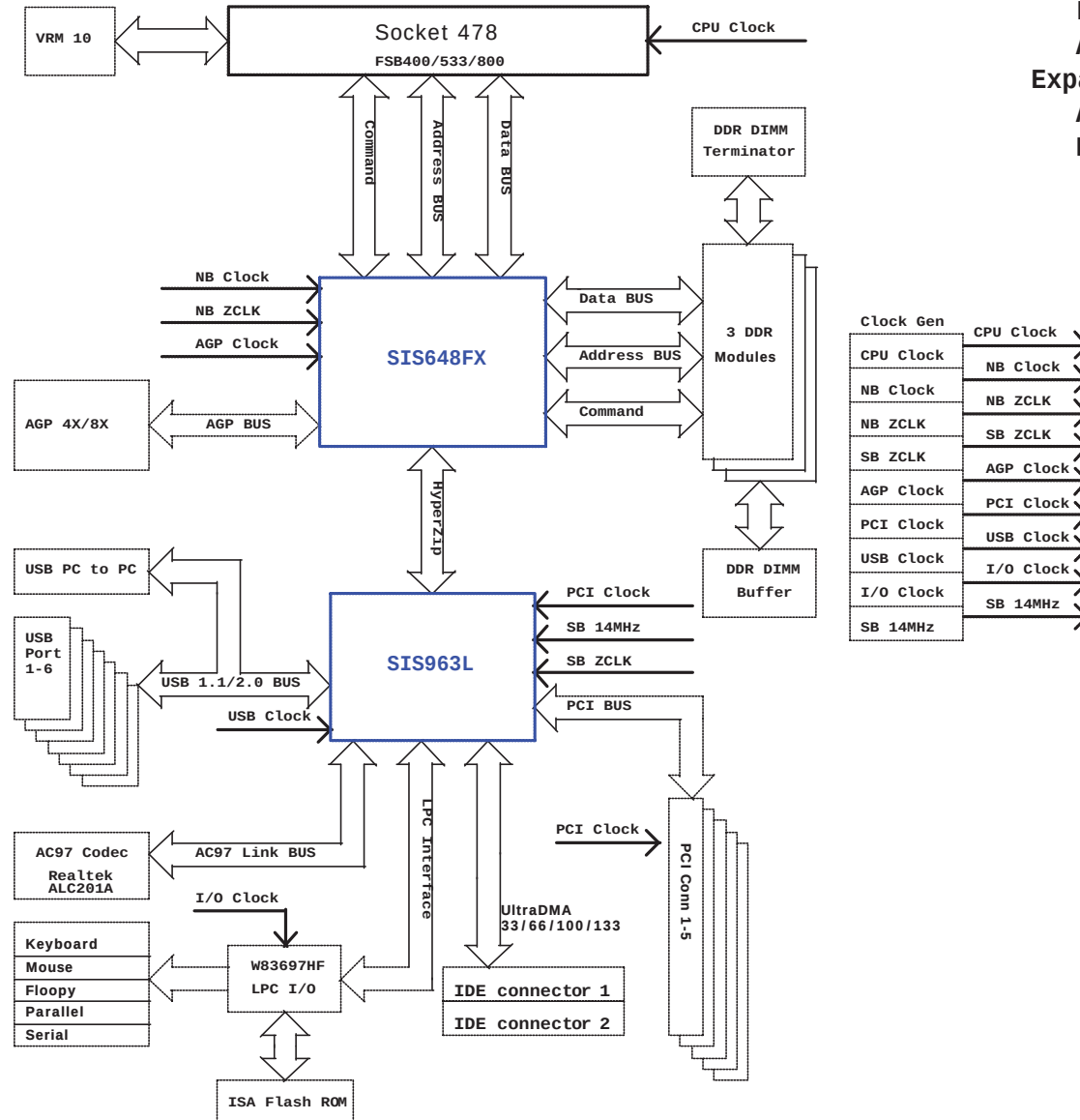
LPC I/O-W83697HF

Audio Codec-Realtek ALC201A

Expansion Slot:

AGP3.0 Slot*1

PCI2.2 Slot*5

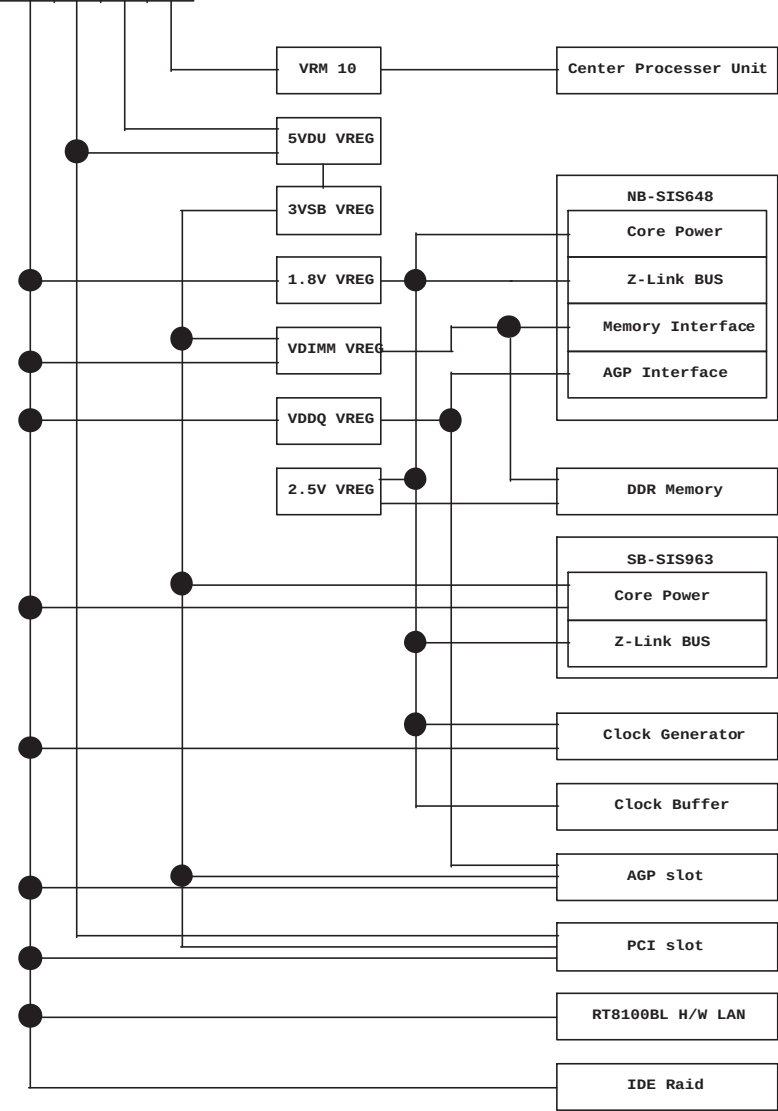


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ATX 12V POWER Supply

3.3V	5V	5VSB 1A	12V
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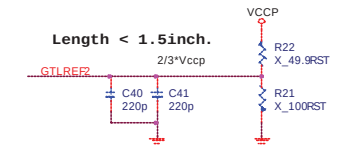
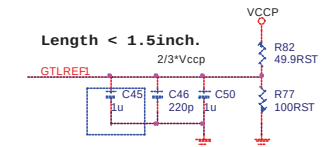
Power Delivery Map



Samsung Electronics			
Title			
Power Delivery			
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Socket478-1

CPU GTL REFERENCE VOLTAGE BLOCK

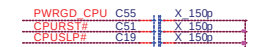
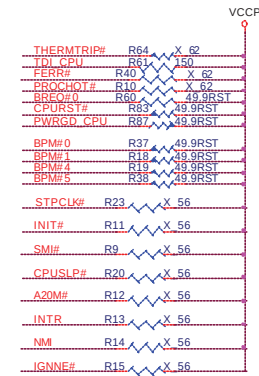


Every pin put one 220pF cap near it.

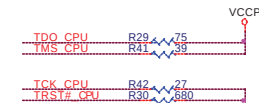
Trace Width 15mils, Space 15mils.

Keep the voltage dividers within 1.5 inches of the first GTLREF Pin

CPU STRAPPING RESISTORS CLOSED TO SOCKET478



CPU ITP BLOCK CLOSED TO SOCKET478

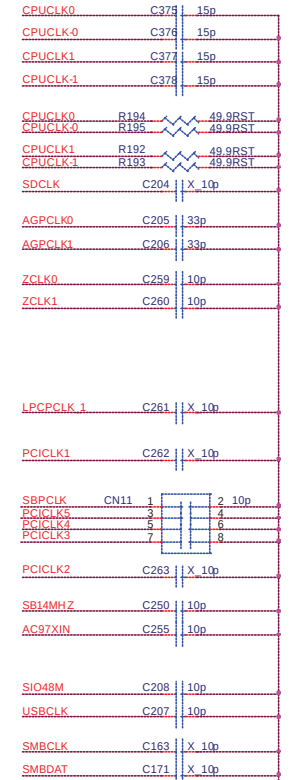
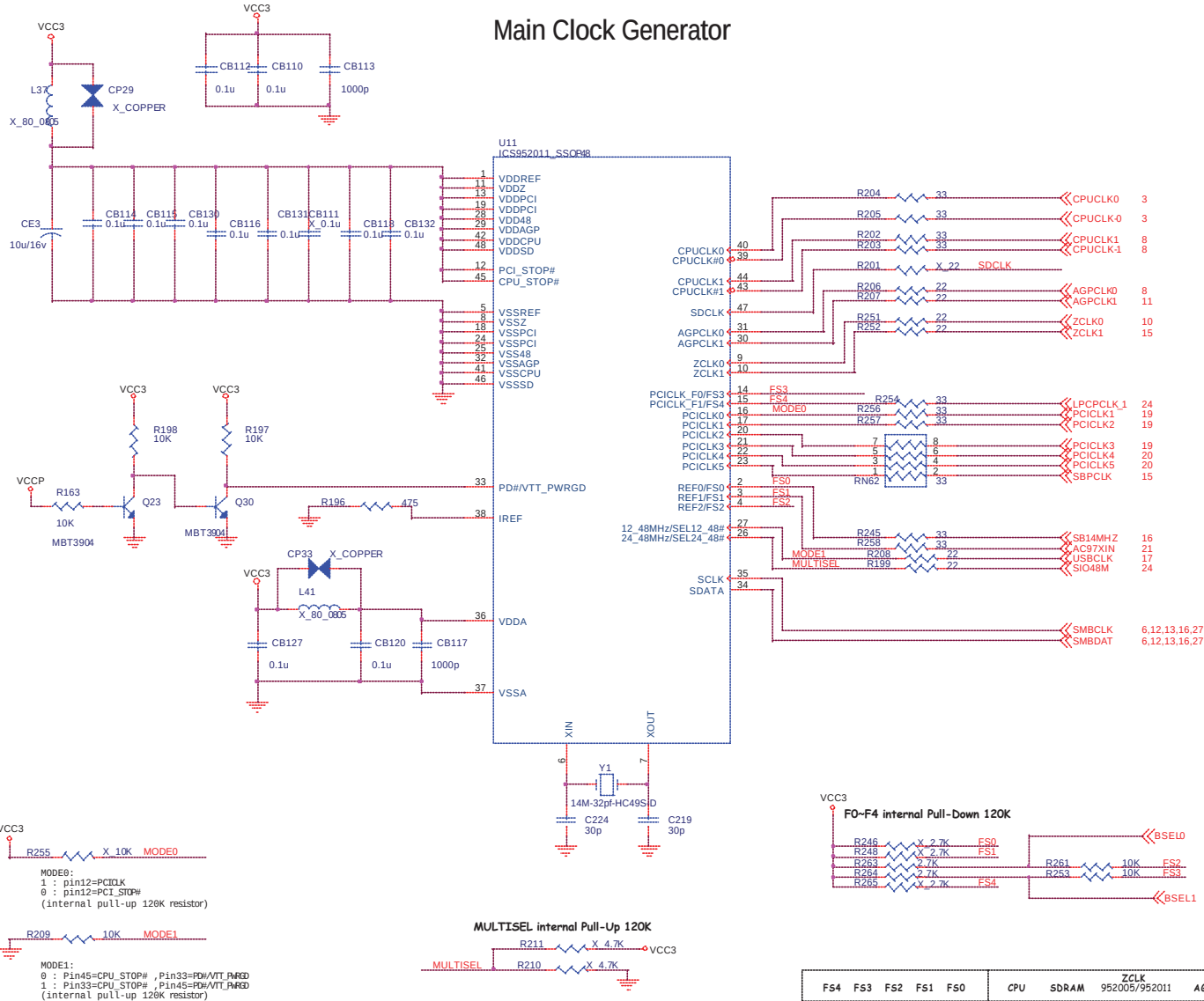


SamSung Electronics

FCPGA478-1

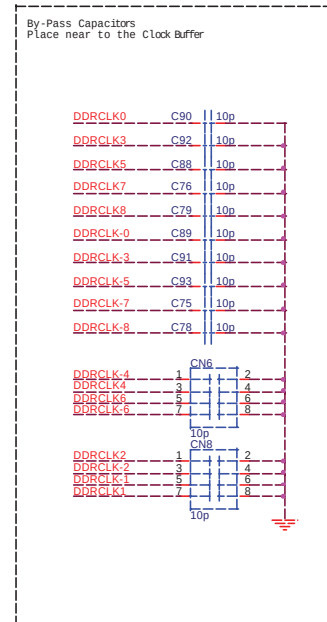
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Main Clock Generator

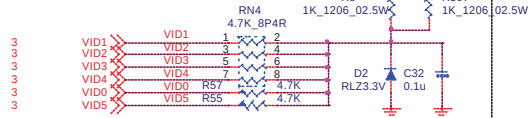


Fs4	Fs3	Fs2	Fs1	Fs0	CPU	SDRAM	ZCLK 952005/952011	AGP	PCI
0	0	0	0	0	100	100	80/66	66	33
0	0	1	0	0	133	100	80/66	66	33
0	1	0	0	0	166	100	80/66	66	33
0	1	1	0	0	200	100	80/66	66	33

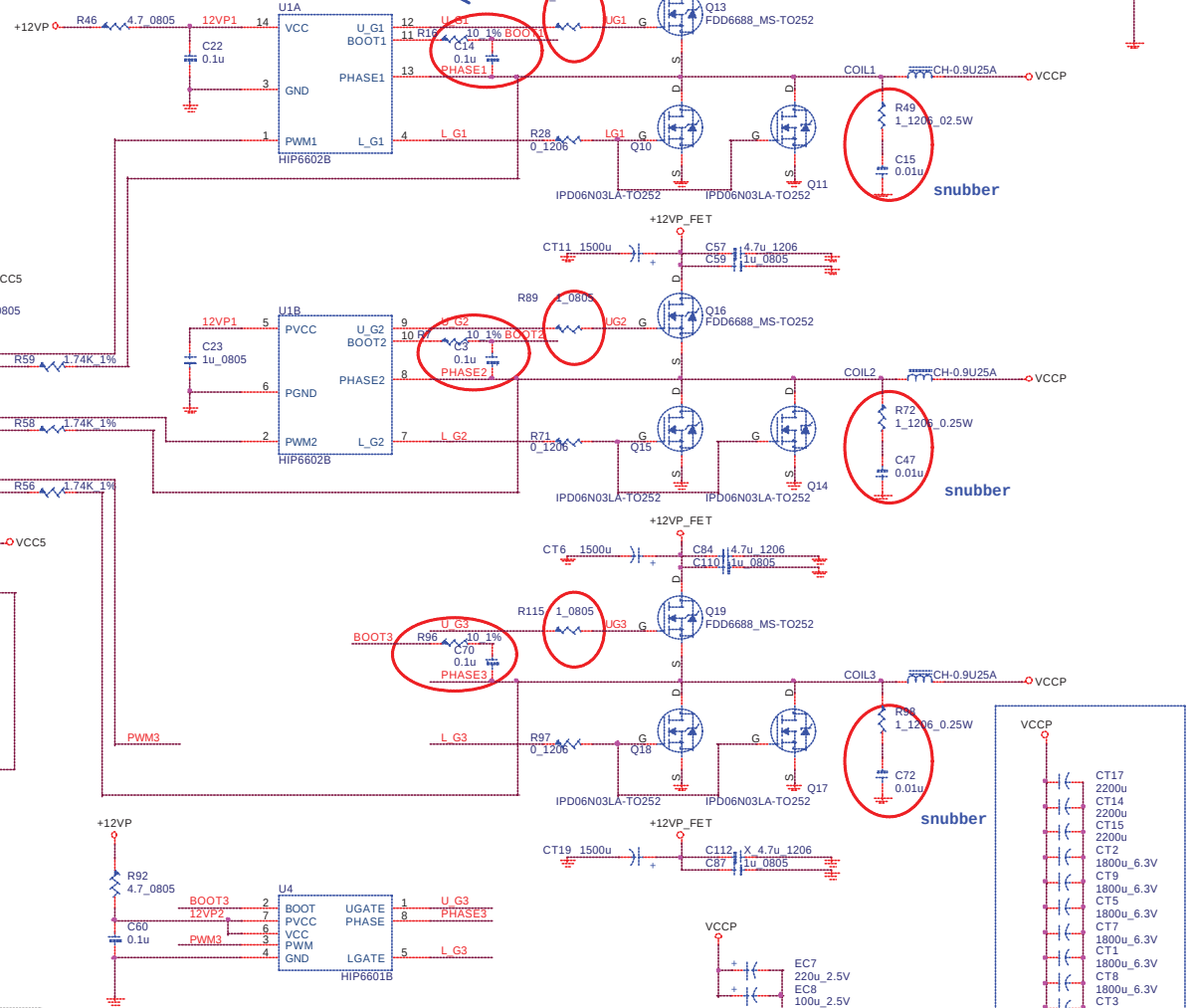
(OPTIONS)
1: (ICS-93705)



VID Pull-Up Resistor



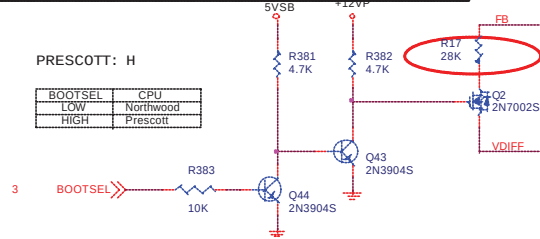
Gate Driver resistor BOOT R/C



NORTHWOOD/PRESCOTT LOAD LINE SELECTOR

PRESCOTT: H

BOOTSEL	CPU
LOW	Northwood
HIGH	Prescott

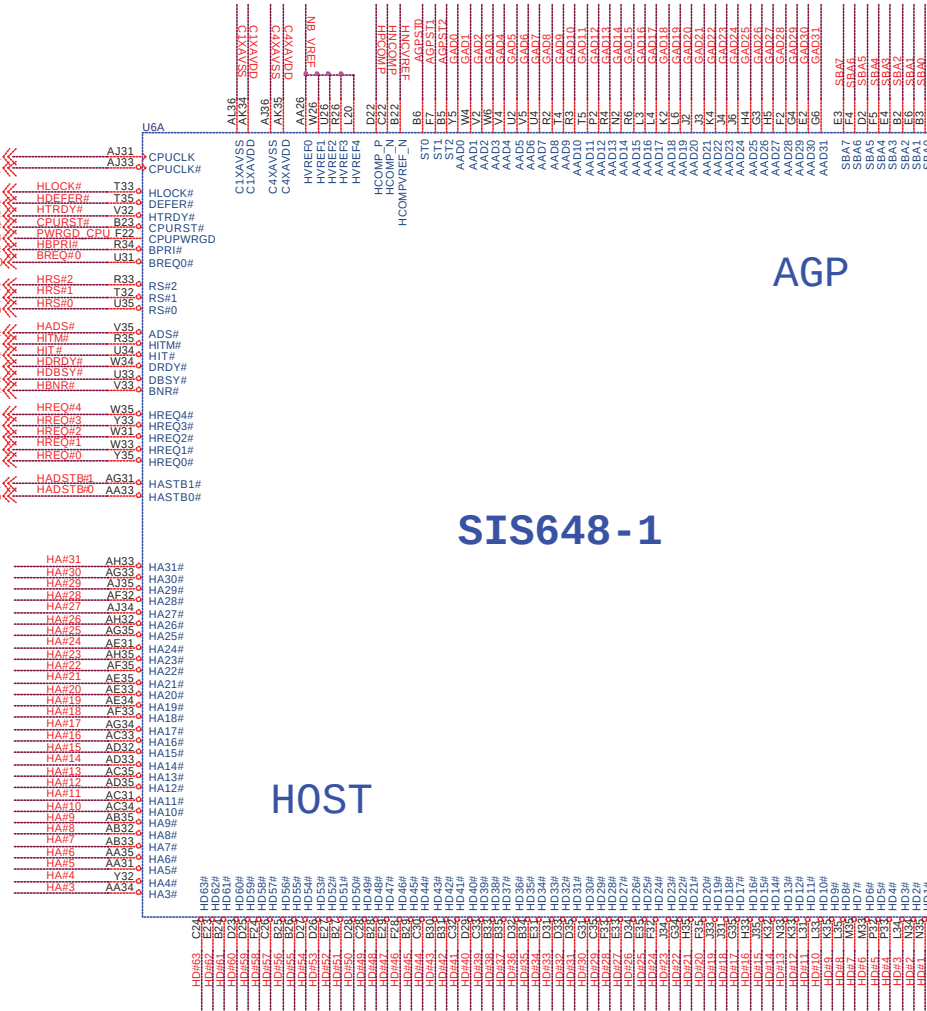


HEAT SINK

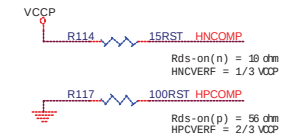
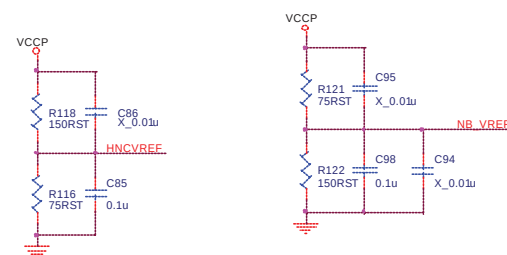
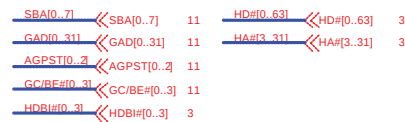
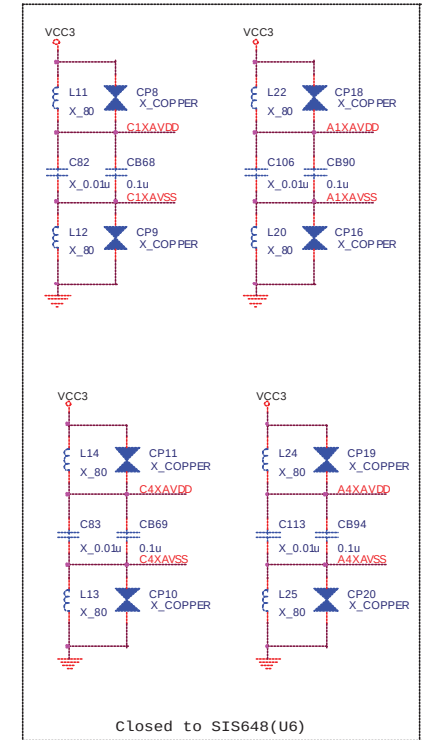
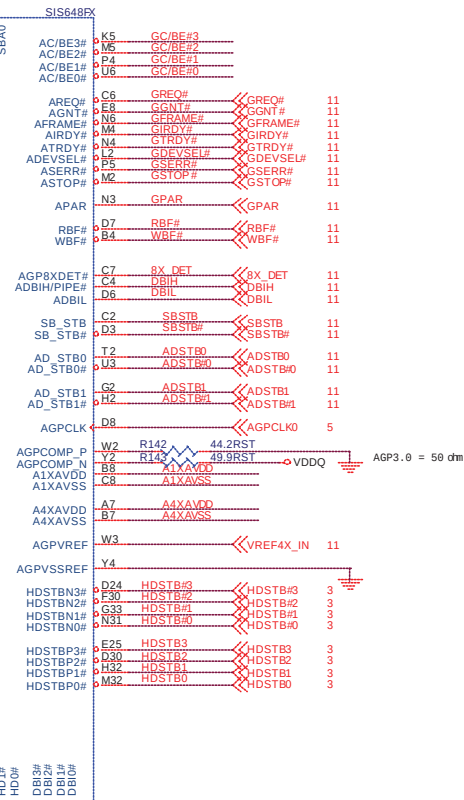


MICRO-STAR INT'L CO., LTD.

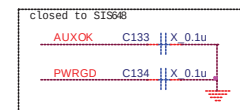
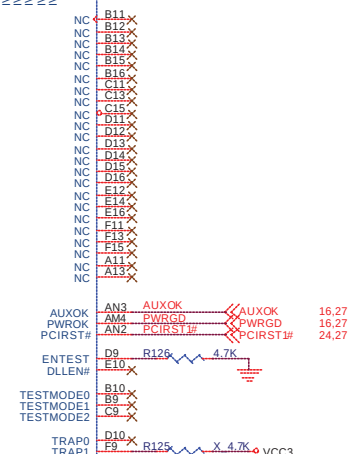
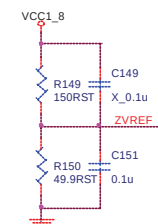
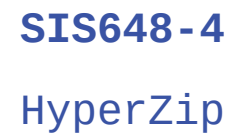
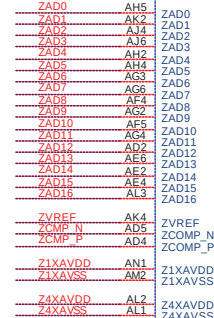
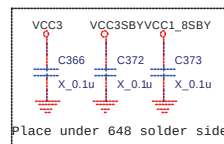
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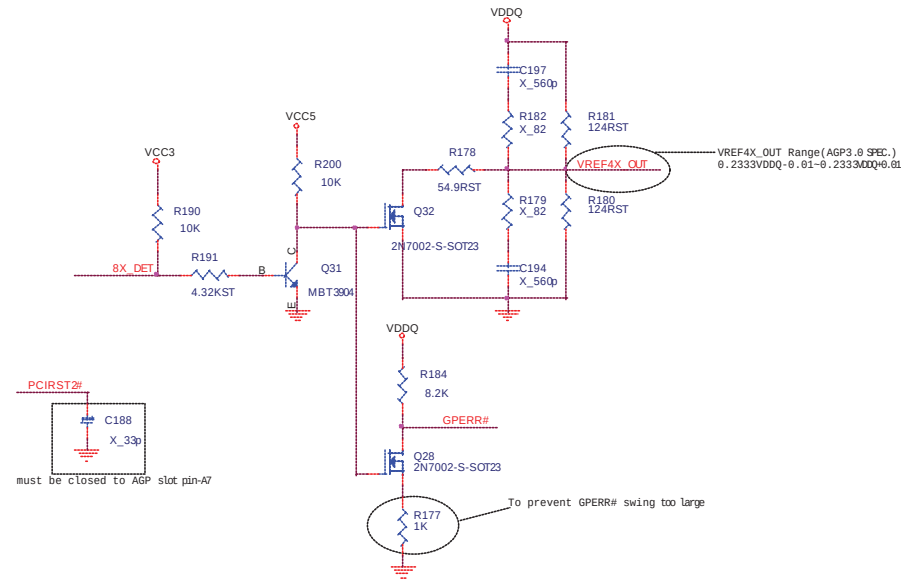
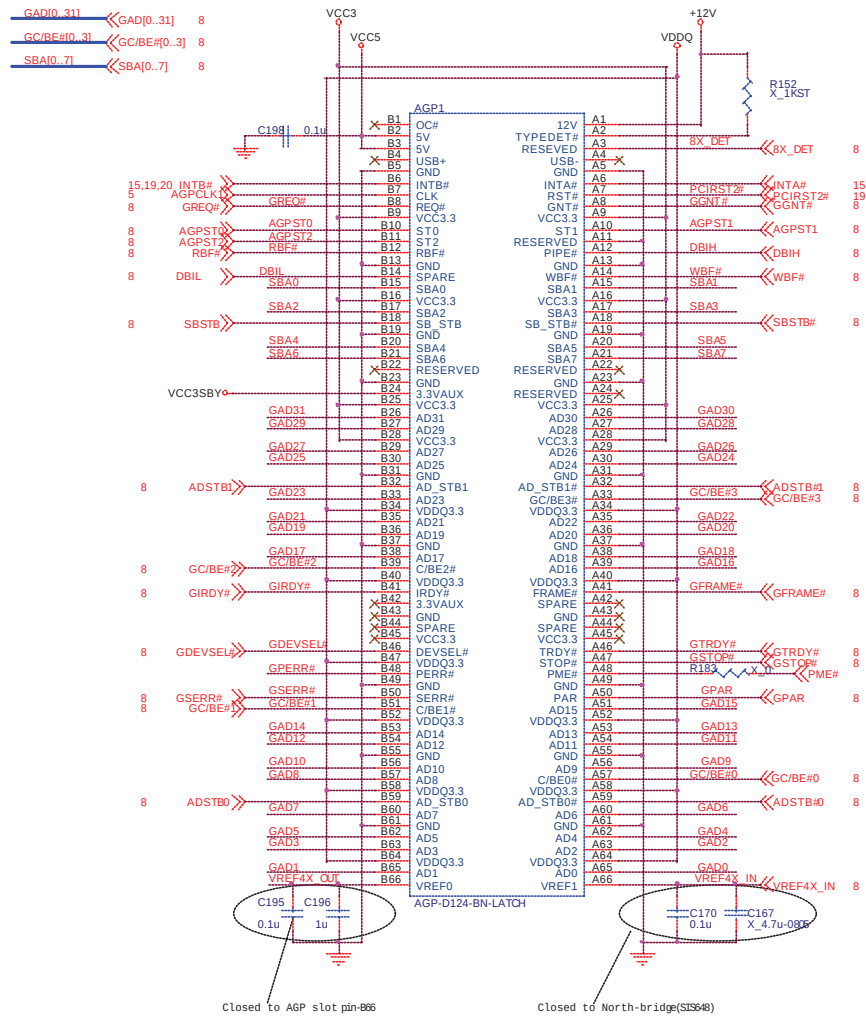


SIS648-1

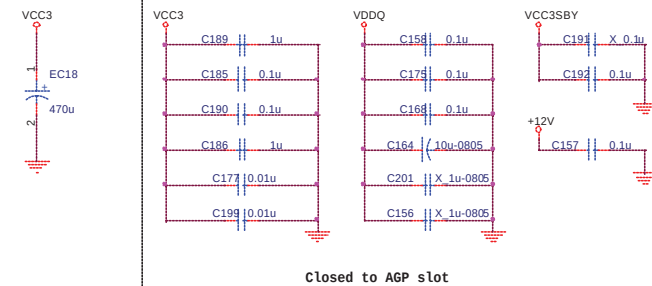


Samsung Electronics		
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SIS648-Host & AGP		
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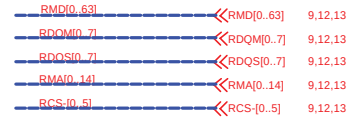




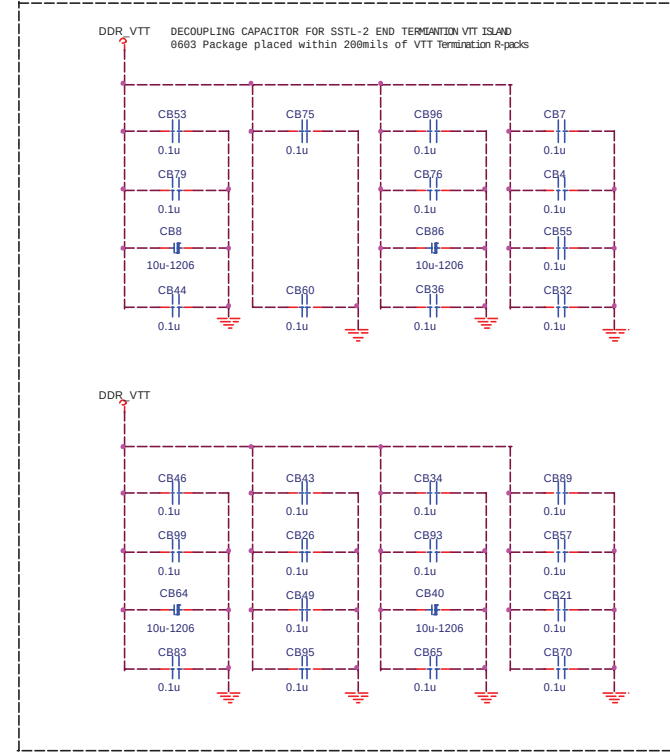
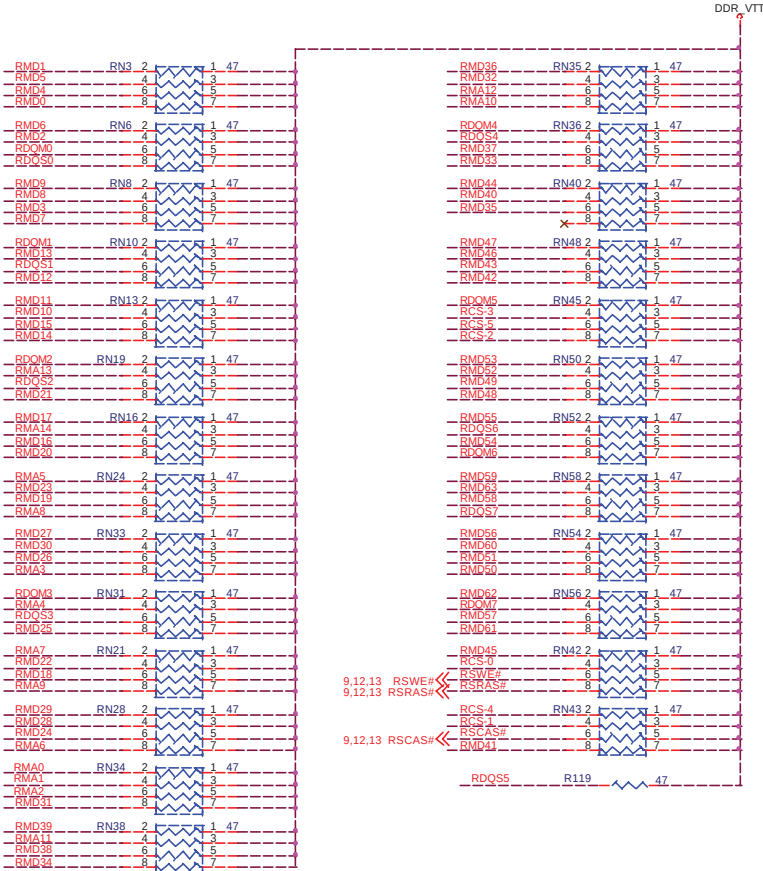
CLOSED TO AGP SLOT

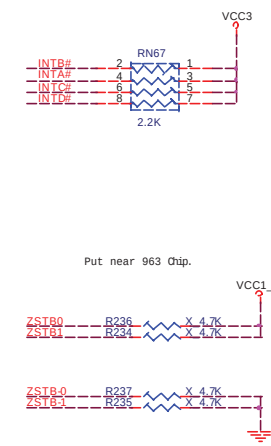


SSTL-2 Termination Resistors



	SPR	Rs	PDR	Rs	Rtt
MD/DQM(/DQS)	LV-CMOS	b/18/-	SSTL-2	b8	83
MA/Control	LV-CMOS	0	SSTL-2	0	83
CS	LV-CMOS	0	SSTL-2	0	47
CKE	DD 3.3V	0	DD 2.5V	0	





Programmable on-die pull-high strength for CPU_S:
(Infinite, 150, 110, 50 Ohm)

CPU_S

APIC

LPC

RTC

963-2

GPIO

AC97

ACPI
/others

KBC
/geyserville

MII

GPIO

U13B

OSC25MHI A8 MIUCLK25M

OSC25MHO A9 MIUCLK

TXCLK A6 MIUCLK

TXEN B6

TXD0 E8

TXD1 D7

TXD2 C6

TXD3 B4

RXCLK A7 MIUCLK

RXD0 D8 MIUCLK

RXD1 A5 MIUCLK1

RXD2 B5 MIUCLK2

RXD3 A4 MIUCLK3

COL B7 MIUCLK

CRS E9 MIUCLK

MDC C5

MDIO E7 MIUCLK

MIIAVDD B9 VCC3SBY

MIIAVSS B8

GPIO0 V2

GPIO1/LDRQ# I8 LDRQ#

GPIO2/THERM# I4 THERM#

GPIO3/EXTSMI# I6 W_PRT

GPIO4/CLKRUN# W1 FDD_DET

GPIO5/PREQ# U5 PREQ#

GPIO6/PGNT# U4 PGNT#

GPIO7 C4

GPIO8/RING C14 RING

GPIO9/AC_SDIN2 E6 AC_SDIN2

GPIO10/AC_SDIN3 B3 AC_SDIN3

GPIO11/OSC25M/STP_PCI# F5 GPIO11

GPIO12/CPUSTP# D4 GPIO12

Reserved for Non-MSL
Must be closed SIS963
19,20 If not use LAN , remove MSL

AC'97 Pull-Down:
In order to stabilize
963 AC'97 controller,
pull-down resistors on
SDAT11 and SDAT19 can
not be removed.

AC_SDIN2 B305 100K

AC_SDIN3 B283 100K

AC_SDIN0 B295 100K

AC_SDIN1 B282 100K

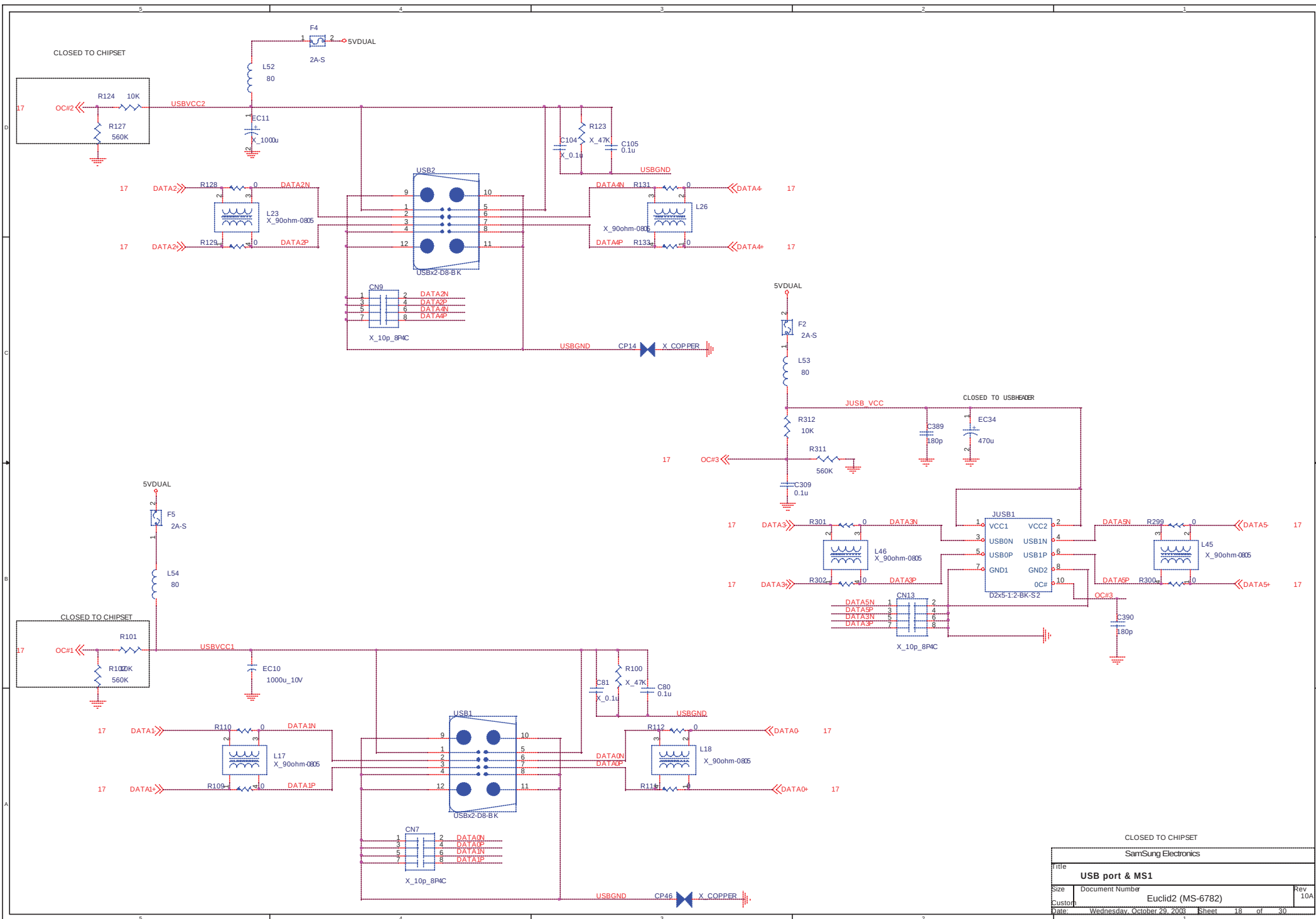
BATTERY BLOCK

Chassis Intrusion Header

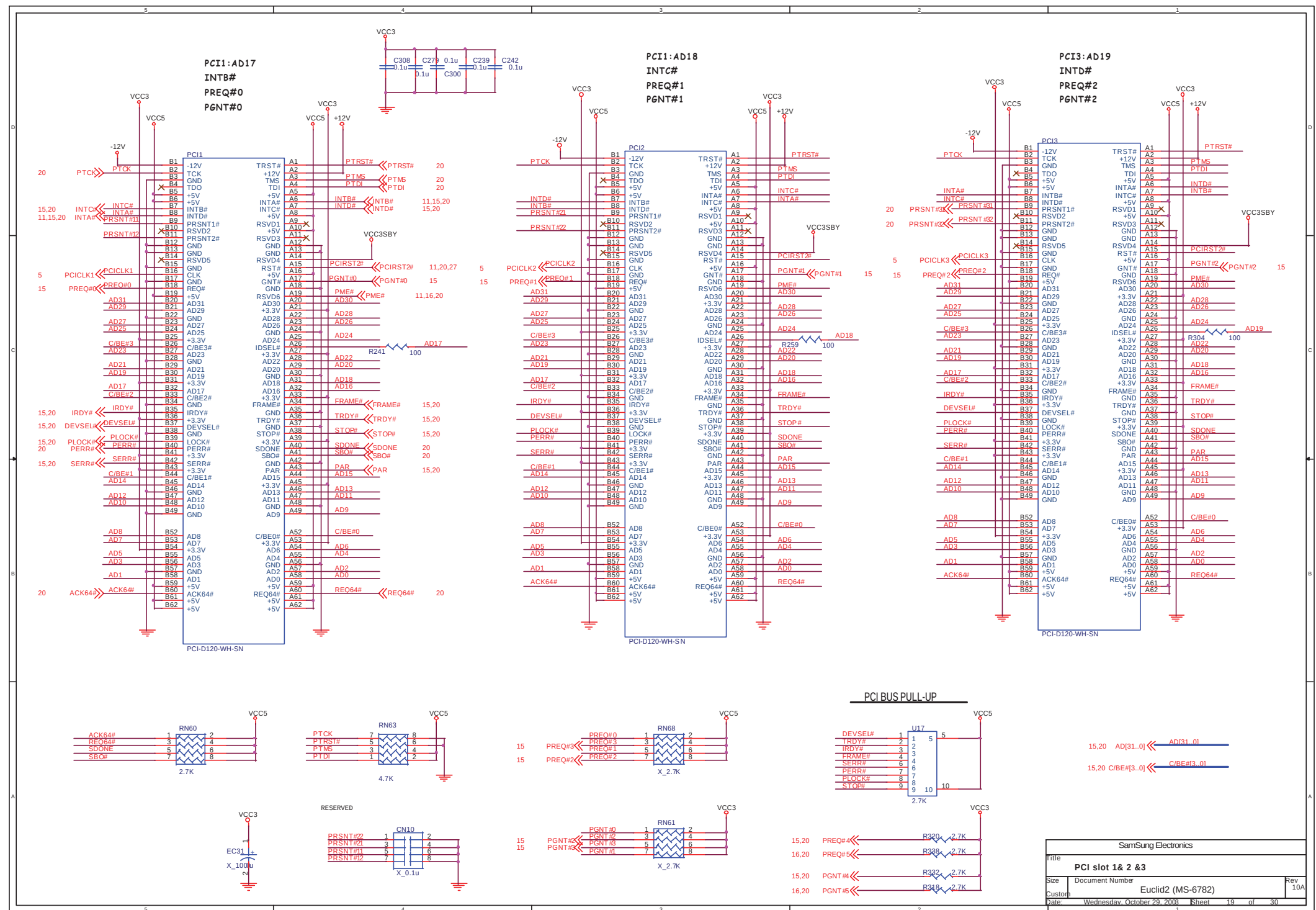
Put closed to 963 QHP

NEED NOT to place close to SIS96X

Samsung Electronics			
Title			
SIS963-2 MSIC.			
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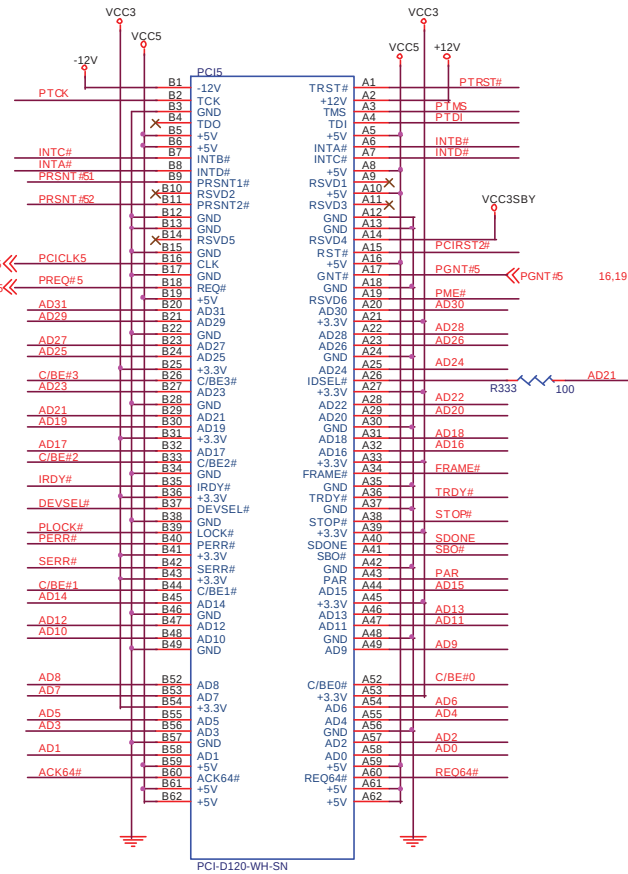
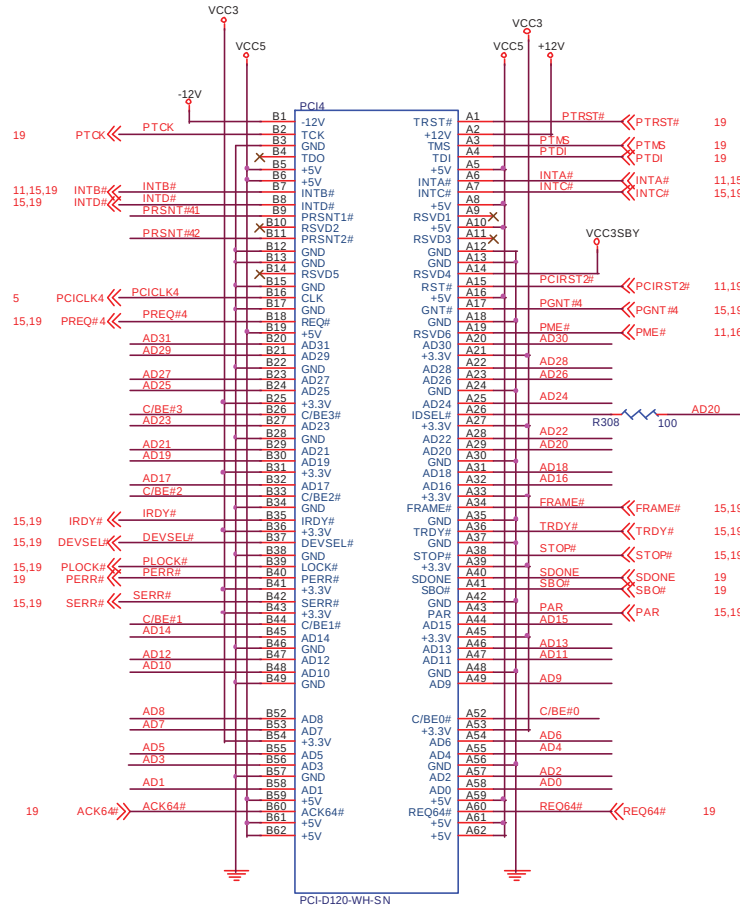


CLOSED TO CHIPSET			
Samsung Electronics			
Title			
USB port & MS1			
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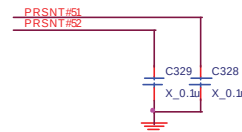
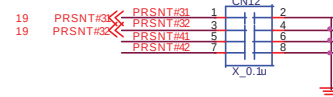


PCI4:AD20
INTA#
PREQ#4(share with M51REQ#)
PGNT#4(share with M51GNT#)

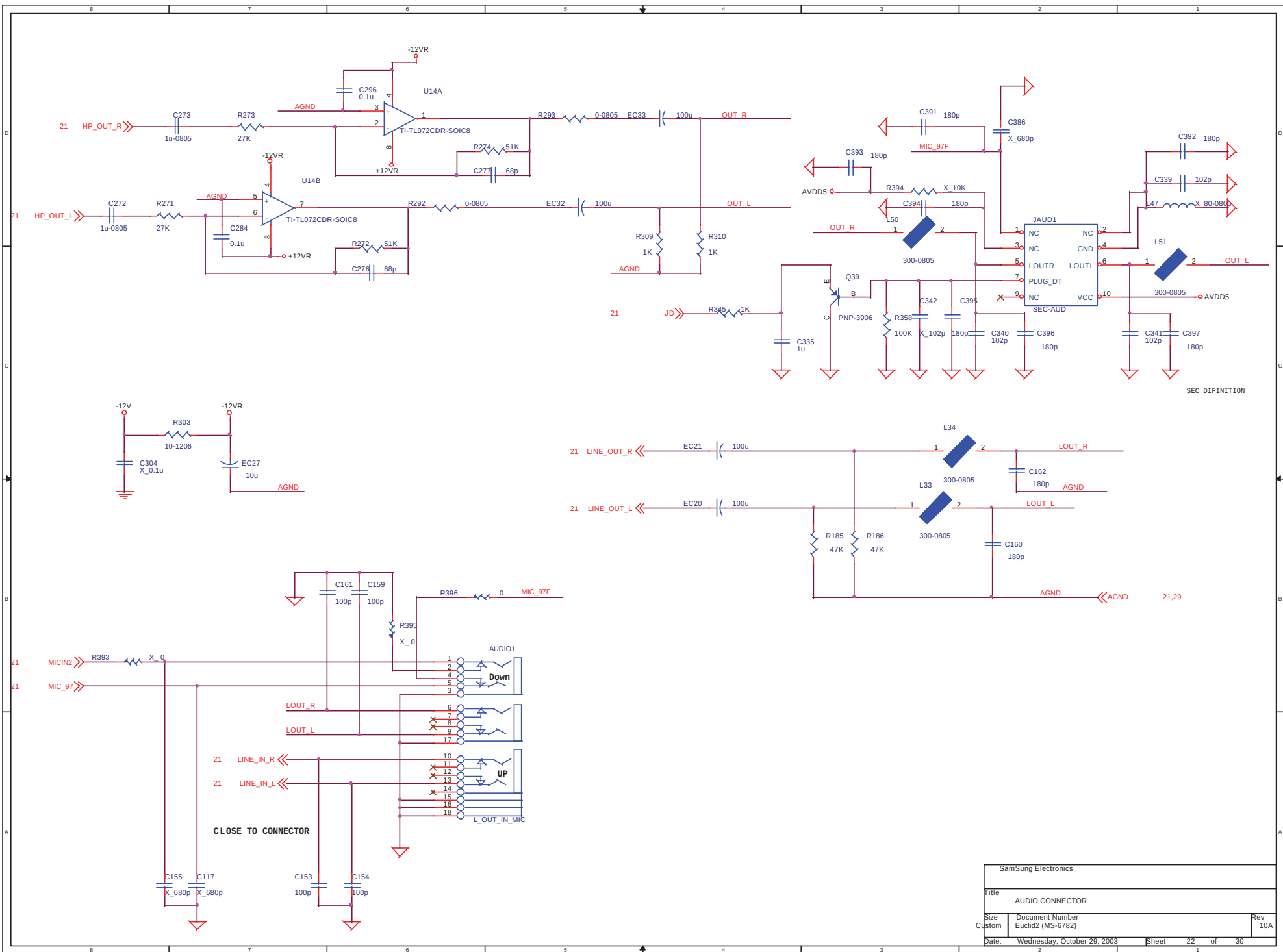
PCI5:AD21
INTB#
PREQ#5(share with LANREQ#)
PGNT#5(share with LANGNT#)



15,19 AD[31..0] << AD[31..0]
15,19 C/BE#[3..0] << C/BE#[3..0]



SamSung Electronics			
Title			
PCI slot 4 & 5			
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STRAPS

INTEL IR

Hardware Monitor

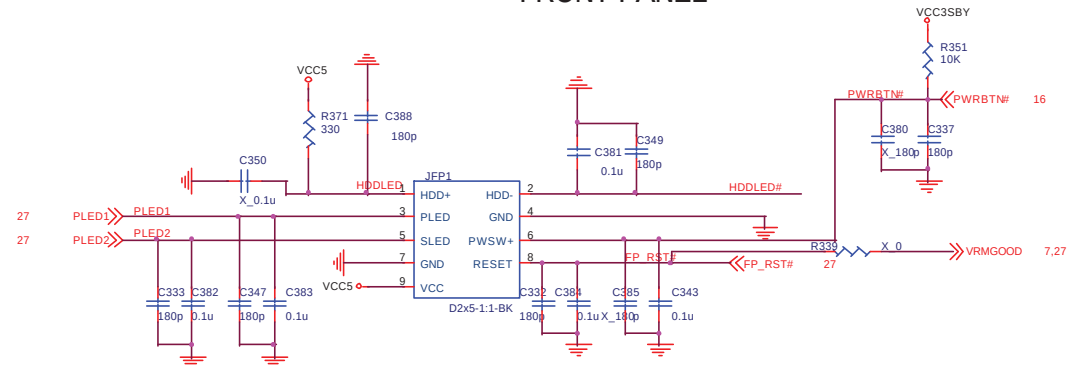
Flash Rom

W83697HF

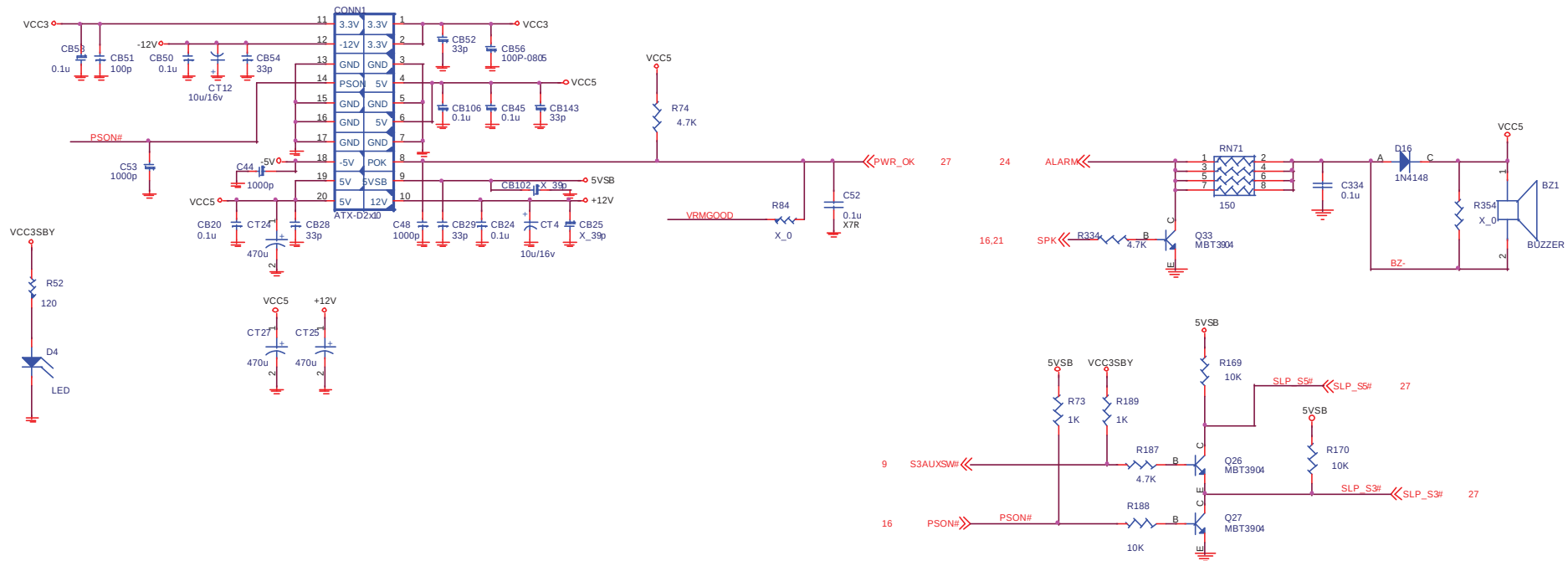
SYSTEM FAN

Samsung Electronics		
W83697HF I/O & BIOS		
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FRONT-PANEL

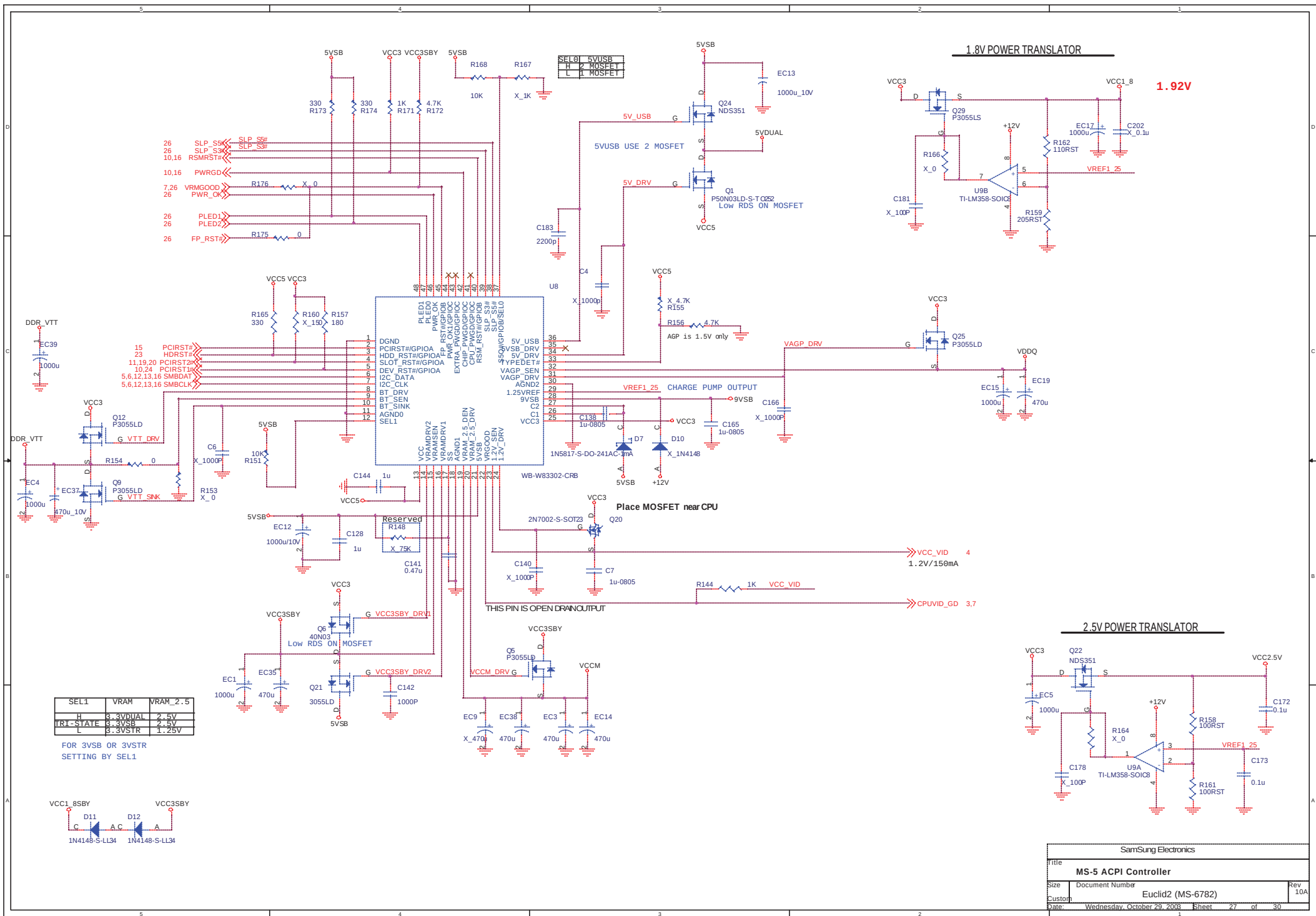


ATX CONNECTOR

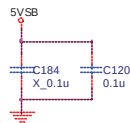
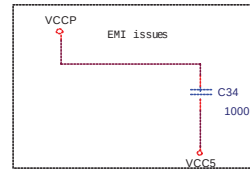
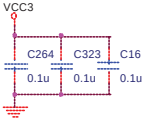
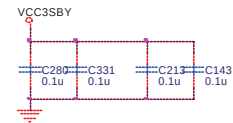
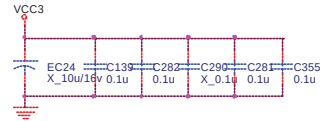
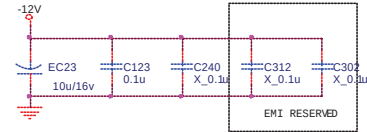
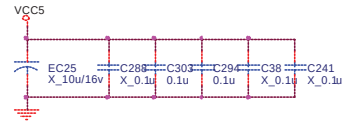
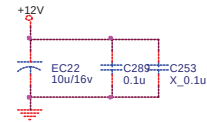
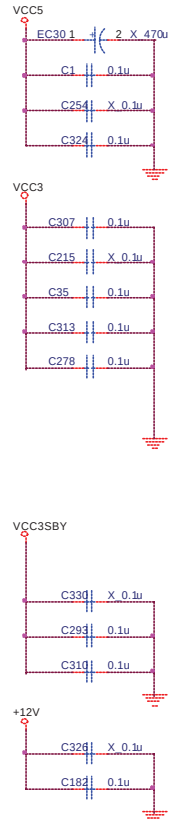


	S0	S3	S
S3AUXSW#	1	0	1
PS0N#	0	1	1
SLP_S5#	1	1	0
SLP_S3#	1	0	0

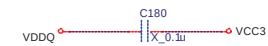
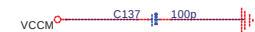
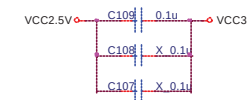
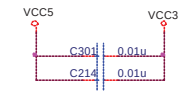
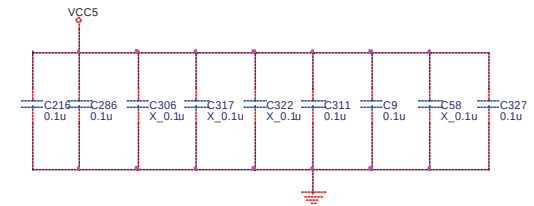
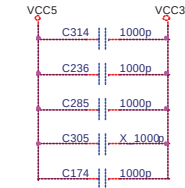
SamSung Electronics			
Title ATX & F-panel & Audio port			
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System Decoupling Capacitors



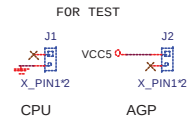
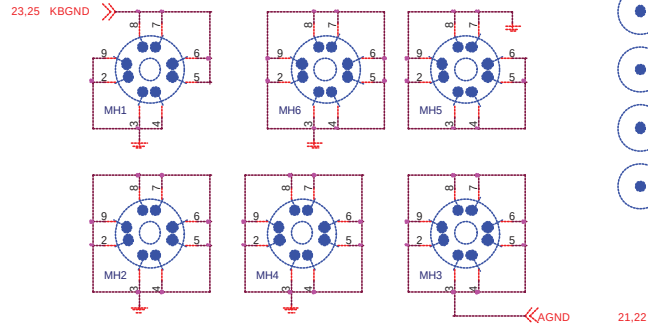
High Freq. return current decoupling



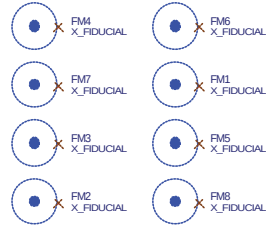
EMI issue

Samsung Electronics			
Title			
Decoupling Capacitor			
Size	Document Number	Rev	
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PCB OTHER COMPONENT



FIDUCIALS



GPIO SPEC. & PCI ROUTING

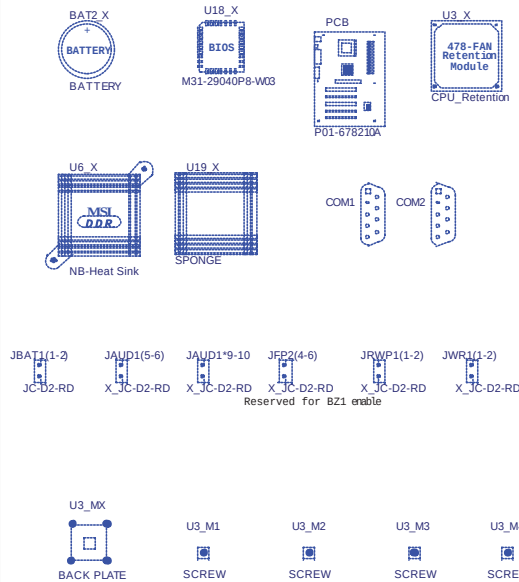
SB(SIS963) GPIO

GPIO	PIN	Function Description
GPIO0	V2	Unused (multifunction pin)
GPIO1	T8	Unused (multifunction pin)
GPIO2	T4	Thermal detect from H/M OVT# (83697HF)
GPIO3	T6	W_PRT(WRITE:HIGH / PROTECT:LOW)
GPIO4	W1	FDD_DET
GPIO5	U5	PCIREQ#5
GPIO6	U4	PCIGNT#5
GPIO7	C4	Unused (multifunction pin)
GPIO8	C14	Wake on RING event (ActiveLow)
GPIO9	E6	Unused (multifunction pin)
GPIO10	B3	Unused (multifunction pin)
GPIO11	F5	Unused (multifunction pin)
GPIO12	D4	Unused (multifunction pin)
GPIO13	B1	CLEAN CMOS (NORMAL:HI / ACTIVE:LOW)
GPIO14	E5	Unused (multifunction pin)
GPIO15	E13	Keyboard Data
GPIO16	A16	Keyboard Clock
GPIO17	D13	Mouse Data
GPIO18	B15	Mouse Clock
GPIO19	A1	Programming for "SMBCLK"
GPIO20	B2	Programming for "SMBDATA"

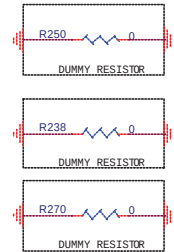
PCI Config.

DEVICE	INT Pin	IDSEL
PCI Slot 1 PREQ#0	INTB# INTC# INTD# INTA#	AD17
PCI Slot 2 PREQ#1	INTC# INTD# INTA# INTB#	AD18
PCI Slot 3 PREQ#2	INTD# INTA# INTB# INTC#	AD19
PCI Slot 4 PREQ#4*	INTA# INTB# INTC# INTD#	AD20
PCI Slot 5 PREQ#5	INTB# INTC# INTD# INTA#	AD21

MANUAL PART



OPTION PART



SamSung Electronics			
Title			
Manual Part & GPIO define			
Size	Document Number	Rev	
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0B

- 1.VRM10 solution from ST 2 phase to Intersirl 6556A 3 phase (page 7).
- 2.Customer request add USB connector (page 18).
- 3.Customer request change connector and remove game port (page 22).
- 4.Customer request mechanical's issue EC35,EC18,EC19 CAP 1000uf to 470uf.
- 5.Customer request mechanical's issue move JCD1,JAUX1.

0C

- 1.Add CP47 for VTIN_GND reduce noise (page 3).
- 2.Reserved R380 for boost external pull up (page 3).
- 3.ADD CN11 for imprve PCCLK rise time (page 5).
- 4.C205 , C206 10P-->33P for AGPCLK rise timing (page 5).
- 5.ADD C375 , C376 , C377 , C378 15P for CPUCLK 0/1 rise timing (page 5).
- 6.Change R26 , R71, R97 0 ohm -->2.2ohm (page 7).
- 7.Update CPU pin definition (page 7).
- 8.Update R47 470K-->NO STUFF and ADD R51-->301K for VRM offset (page 7).
- 9.Update R56 , R58 , R59 4.32K-->1.74K for VRM ocp (page 7).
- 10.Update R27, R28-->3.3K , R17 20K-->28K , R31 15K-->30K (page 7) .
- 11.EC3 220u-->100u (page 7).
- ~~12.Add C77 3p and change R103 22 ohm -->33 ohm for improve timing (page 6).~~
- 13.CT10 , CT13 change to 1000u/10V , Dip-2/8,16/3.5mm for mechanical's issue customer's request(page 7).
- 14.Add C114 , C118 , C119 , C124 , C145 , C148 for VCCM decoupling CB59 , CB63 for DDRPULL dcoupling (page 9).
- 15.Add C11 , C12 , C20 for DDR VREF dcoupling (page 12,13).
- 16.Add CB14,CB16,CB26,CB34,CB36,CB43,CB44,CB46,CB53,CB57 , CB70 , CB89,CB93,CB96 0.1u,CB64 10u for DDR VTT coupling (page 14).
- 17.Add F4 , F18 , polyswitch/miniSMDC200 , 2A/6V/0.070 , SMT/1812 , It=4A, UL7/CSA/TUV,CN13-->10P for EMI (page 18).
- 18.Modify JCD1 , JAUX1 pin define and bom for customer's request (page 21).
- 19.Add R385 , R386 2.2K , reserved R387 0 ohm for MIC2 option (page 22).
- 20.Add R3 to improve 5VDUAL discharge time(page 23).
- 21.Reserved C374 for coupling (page24).
- 22.Add R356 0 ohm to support 4W flash part (page 24).
- 24.Add EC37 for DDR VTT power (page 27).
- 25.Reserved EC38 for DDR VCC power (page 27).
- 26.Change R1 , 3955LD to 50N03LD(DIS,mofet/n-channel, P50N03LD, SMT/T0252, Rds(on)=12m0, Vgs(on)=1V, Id=50A, Ciss=1800pf, Qg=50nC, Vds=27V, Vgs=±20V) for USB's voltage drop customer's requirement (page 27).
- 27.Update SIO version.
- 28.ADD L50 , L51 for EMI (page 22).
- 29.Add C380 , C381 , C382 , C383 , C384 , C385 for ESD (page 22).
- 30.Add CN1 220p for EMI (page 23).
- 31.EC10 , EC13 000u-3v for +12VP.FET--customer's requirement (page 18 , 27).
- 32.DDR COM_P 40.2 ohm--> 22 ohm , DDR COM_N 40.2 ohm -->28 ohm for DDR margine(page 9).
- 33.Add R395 0 ohm reserve R396 0 ohm R394 10K , C386 for support front MIC2(page 22).
- 34.Reserve OSC circuit (page 15).
- 35.R159 215 ohm --> 205 ohm , chip's vocre voltage up to 1.92V(page 16).
- 36.Add CB 8 , 14 , 53 , 96 for VTT decoupling(page 14).
- 37.THERMDC short to GND avoid noise (page 3).
- 38.Reserve EC9 470uf (page 27).
- 39.Add CB 10 , 18 , 41 , 48 , 74 , 78 , 87 , 88 for VCCM decoupling (page 13).
- 40.R271,R273-->27K , R272,R274-->51K , R292,R293-->0 ohm for audio quality(page 22).
- 41.EC3 1000u-4->470uf (page 7).
- 42.Add CB71,84 220p for EMI (page 6).
- 43.Add CT24 470uf for Vcc5(page 26).
- 44.Add CB51 , CB56 , C137 100P for EMI (page 26).
- 45.Add R370 , Q4 for THERM# function (page 24).
- 46.Change NB heatsink
- 47.Add R47-->470K , R27 3.3K change to 3.09K For VRM load line (page 7).

100

- 1.Change CE2 CAP to CAP,MLCC,10u/10V/Y5V,1206,80/-20% customer's request (page 6).
- 2.Reserved CT16 for customer's request (page 7).
- 3.Reserved R397 R, resistor,1kohm/5%/1/4W,1206 customer's request (page 7).
- 4.RN4 , R55 , R57 1K-->4.7K (page 7).
- 5.R33,R34 R343,R348change to R, resistor,4.7Kohm/5%/1/10W 0603 customer's request (page 24).
- 6.Change Q8 MOS to DIS,mofet/p-channel, 1RFR5305, SMT/T0-252, Rds(on)=0.0650, Vgs(on)=2V, Id=31A, Ciss=1200p, Qg=63nC, Vds=31V, Vgs=±20V (page 24).
- 7.Reserved EC39 1000u DDR VTT for customer's request (page 27).
- 8.Reserved CT27 for VCC5 customer's request (page 26).
- 9.Add L52 53,54 , for customer's request (page 18).
- 10.Add C389 , C390 for ESD (page 18).
- 11.Add C388 for ESD (page 26).
- 12.Add C391 , C392 , C393 , C395 , C396 , C397 for ESD (page 22).
- 13.L47 no stuff for ESD (page 22).
- 14.C380 , C385 no stuff for ESD (page 26).
- 15.Add CT22 10u 0805 for 3VSB (page 17).
- 16.Add CT25 470u 16V for VCC12 (page 26).
- 17.CN7 , 9 , 13 remove improve for USB timing (page 18).
- 18.Remove CB 12 , 14 (page 18).
- 19.Remove R340 , R341 , R343 , RR344 , R348 , R349 , C354 , EC36 Q34 , Q35 , D20 , NBFAN FOR REMOVE SYSTEM FAN FUNCTION. (page 24).
- 20.Remove U18 flash part socket (page 24).

100 to MP

- 1.Change R8,R397 to 1kohm/5%/1/4W---customer's request (page 7).
- 2.Add CT16 1500u/6.3V for +12VP.FET---customer's request (page 7).
- 3.Add CT17 2200u/6.3V for VCCP---customer's request (page 7).
- 4.Change R34 from 4.7Kohm to 5.1Kohm for customer's request (page 24).

0825

- 1.R28, R71,R97 from 2.2ohm to 0ohm (page7).
- 2.R7, R16,R96 from 20hm to 10ohm (page7).
- 3.R27 form 3.09K to 3.01K (page7).
- 4.R47 form 470K to 182K (page7).
- 5.O13,16,19 O13 change 09N03 to 066880B (page7).
- 6.Add CB23,27,33 10u (page4).

100--->10A

- 1.page #29:modify PCB version to 6782-10A for signal to NPTH spacing 15 mil from SEC request@2003/10/29

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Title			
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